SYSTEM AND METHOD FOR MINIMIZING INCREASES IN VIA RESISTANCE BY APPLYING A NITROGEN PLASMA AFTER A TITANIUM LINER DEPOSITION

## Inventors:

6

Sergei Drizlikh 10 Sequoia Lane Scarborough Cumberland County Maine 04074 Citizen of Israel

Thomas John Francis
42 Massachusetts Avenue
South Portland
Cumberland County
Maine 04106
Citizen of the United States of America

## Assignee:

National Semiconductor Corporation 2900 Semiconductor Drive Santa Clara, California 95051

William A. Munck Davis Munck, P.C. Three Galleria Tower 13155 Noel Road, Suite 900 Dallas, Texas 75240 (972) 628-3600